



5N80-FCQ

Power MOSFET

5.0A, 800V N-CHANNEL POWER MOSFET

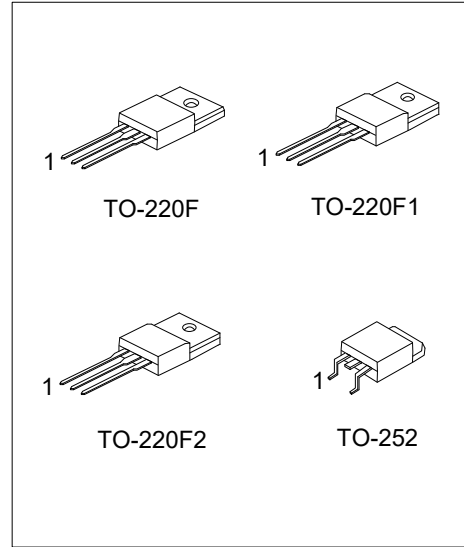
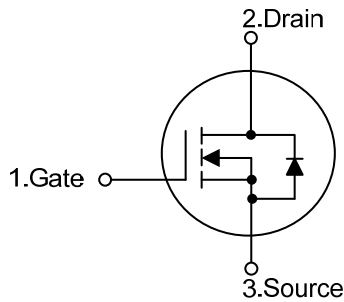
DESCRIPTION

The UTC **5N80-FCQ** provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * $R_{DS(ON)} \leq 3.3 \Omega$ @ $V_{GS}=10V$, $I_D=2.5A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL



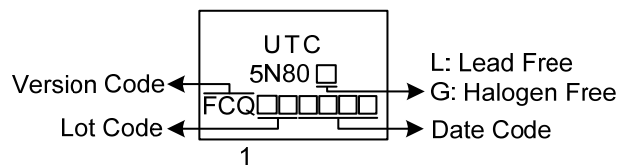
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
5N80L-TF1-T	5N80G-TF1-T	TO-220F1	G	D	S	Tube
5N80L-TF2-T	5N80G-TF2-T	TO-220F2	G	D	S	Tube
5N80L-TF3-T	5N80G-TF3-T	TO-220F	G	D	S	Tube
5N80L-TN3-R	5N80G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

5N80G-TF1-T (1) Packing Type (2) Package Type (3) Green Package	(1) T: Tube, R: Tape Reel (2) TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	800	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current		I_D	5	A
Pulsed Drain Current (Note 2)		I_{DM}	10	A
Avalanche Energy (Note 3)	Single Pulsed	E_{AS}	165.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2	V/ns
Power Dissipation ($T_A=25^{\circ}\text{C}$)	TO-220F/TO-220F1	P_D	33	W
	TO-220F2			
	TO-252		46	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 30\text{mH}$, $I_{AS} = 3.3\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD} \leq 5.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F/TO-220F1	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-220F2			
	TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220F/TO-220F1	θ_{JC}	3.7	$^{\circ}\text{C}/\text{W}$
	TO-220F2			
	TO-252(Note)		2.6	$^{\circ}\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

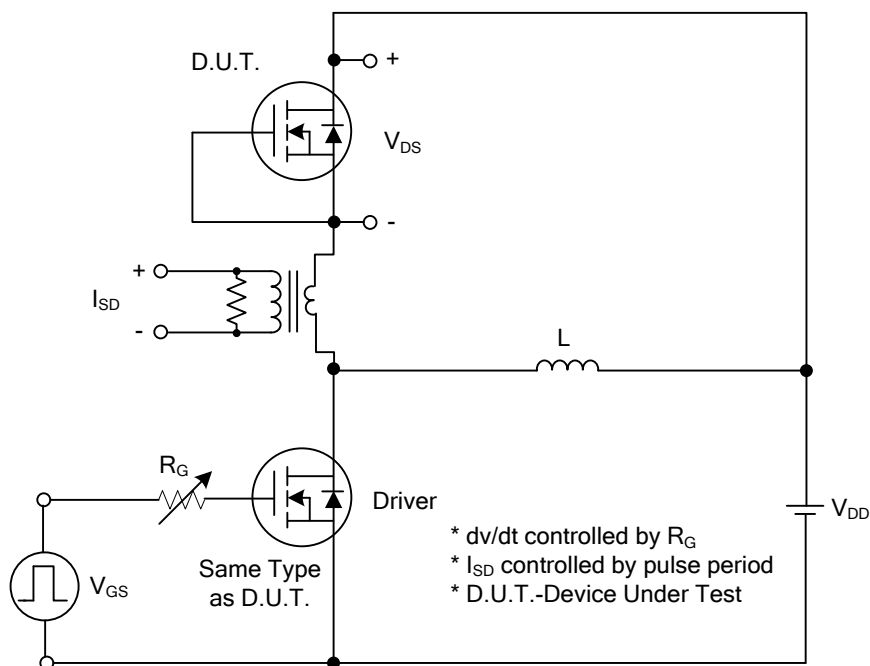
■ **ELECTRICAL CHARACTERISTICS** ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	800			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =800V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	3.0		5.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =2.5A			3.3	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		674.9		pF
Output Capacitance		C _{OSS}			73		pF
Reverse Transfer Capacitance		C _{RSS}			2.1		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q _G	V _{DS} =640V, V _{GS} =10V, I _D =5.0A (Note 1, 2)		16		nC
Gate-Source Charge		Q _{GS}			8		nC
Gate-Drain Charge		Q _{GD}			1.9		nC
Turn-On Delay Time		t _{D(ON)}	V _{DD} =100V, V _{GS} =10V I _D =5.0A, R _G =25Ω (Note 1, 2)		8.3		ns
Turn-On Rise Time		t _R			15.5		ns
Turn-Off Delay Time		t _{D(OFF)}			28.9		ns
Turn-Off Fall Time		t _F			27		ns
DRAIN-SOURCE DIODE CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				5	A
Continuous Drain-Source Current		I _{SD}				10	A
Drain-Source Diode Forward Voltage		V _{SD}	I _S =5.0A, V _{GS} =0V			1.4	V
Reverse Recovery Time		t _{rr}	I _F =5.0A, di/dt=100A/μs		570		ns
Reverse Recovery Charge		Q _{rr}			8.6		μC

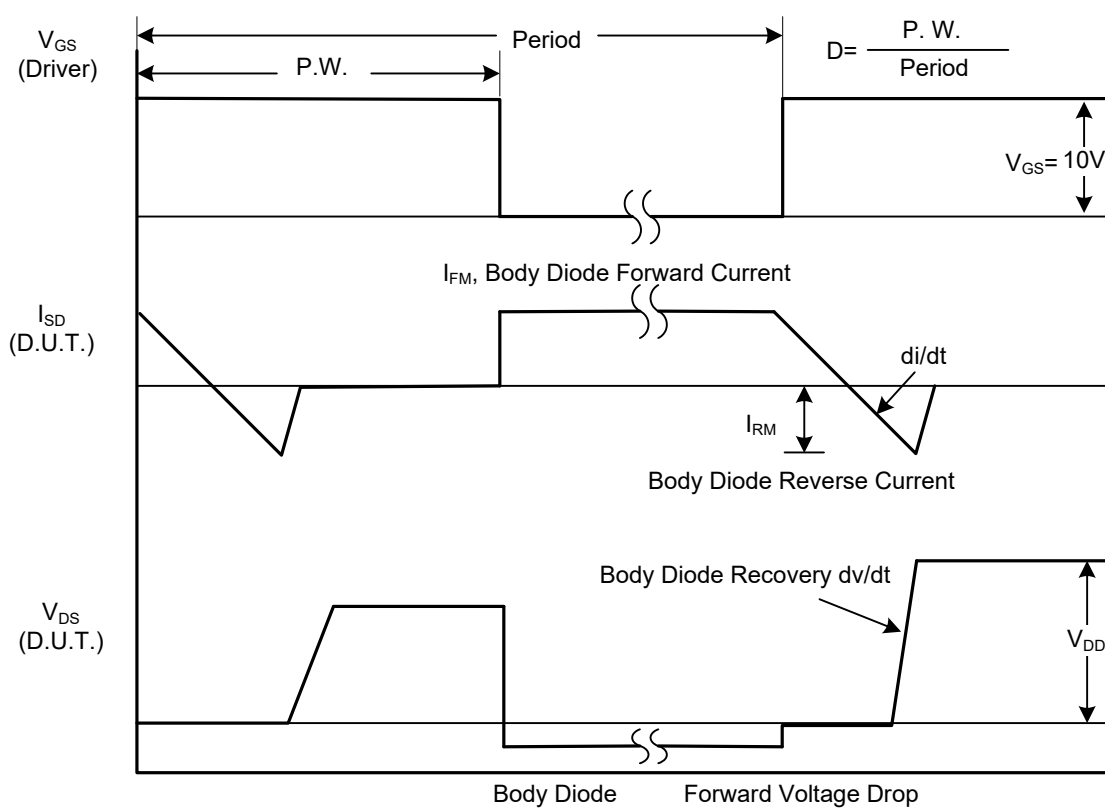
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

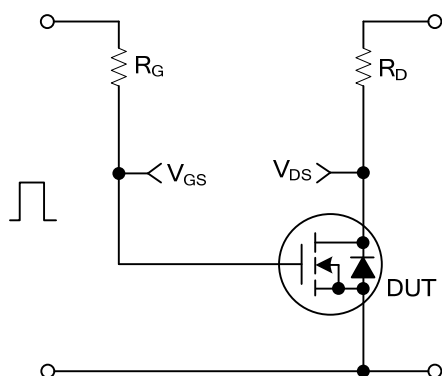


Peak Diode Recovery dv/dt Test Circuit

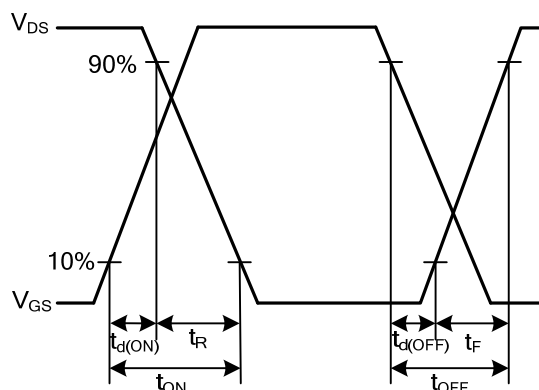


Peak Diode Recovery dv/dt Waveforms

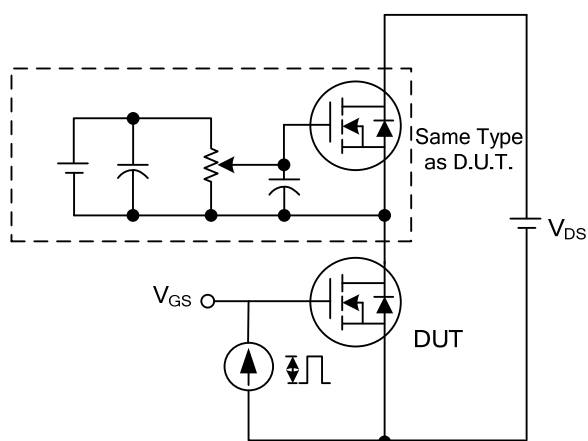
■ TEST CIRCUITS AND WAVEFORMS



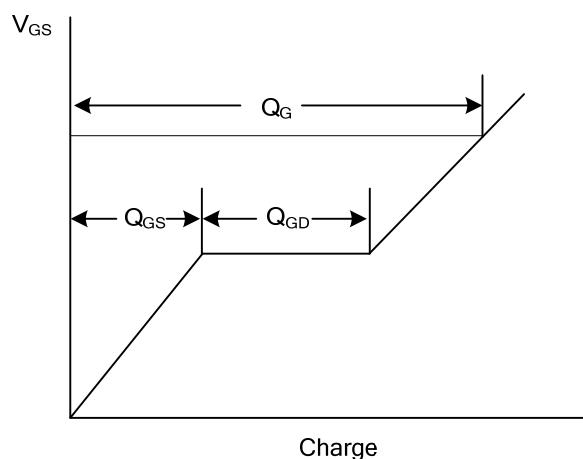
Switching Test Circuit



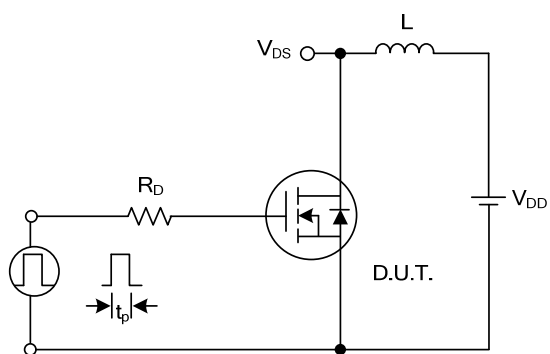
Switching Waveforms



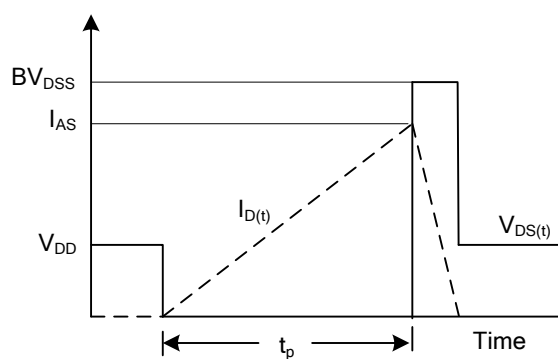
Gate Charge Test Circuit



Gate Charge Waveform

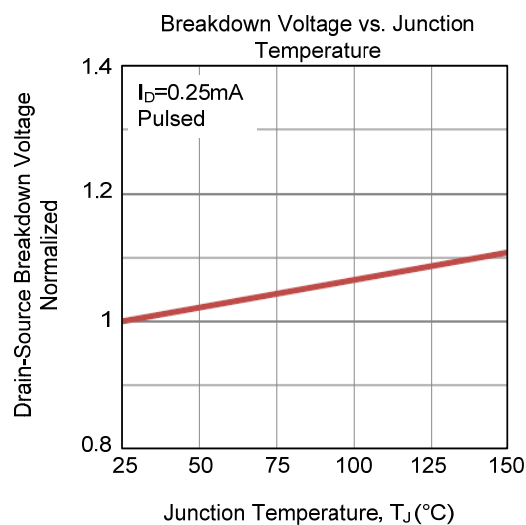
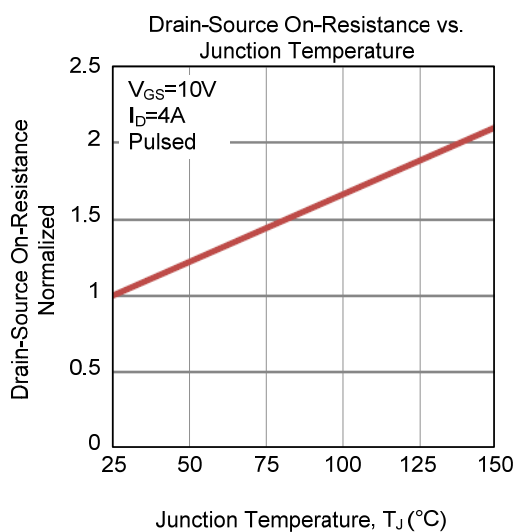
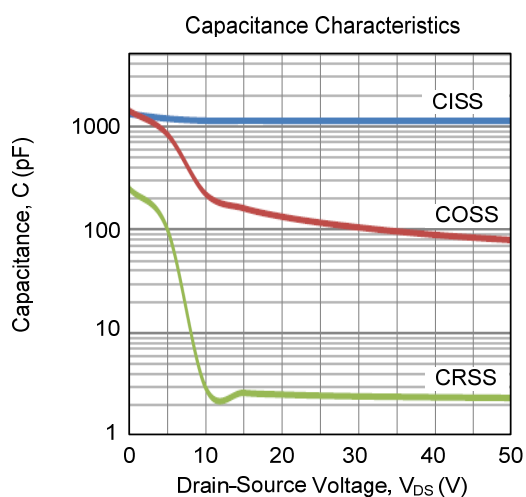
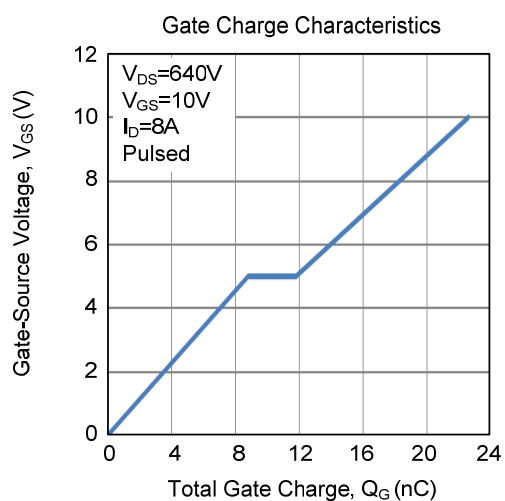
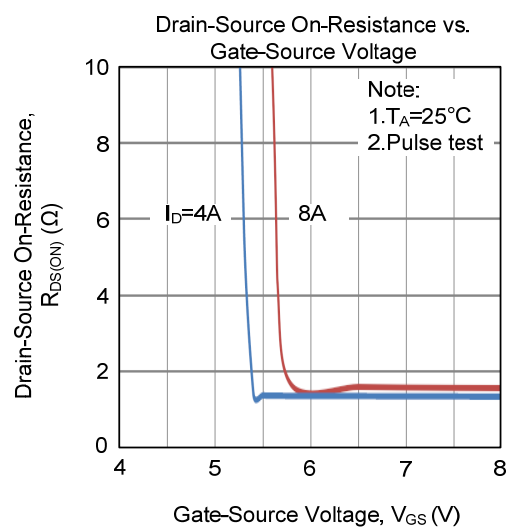
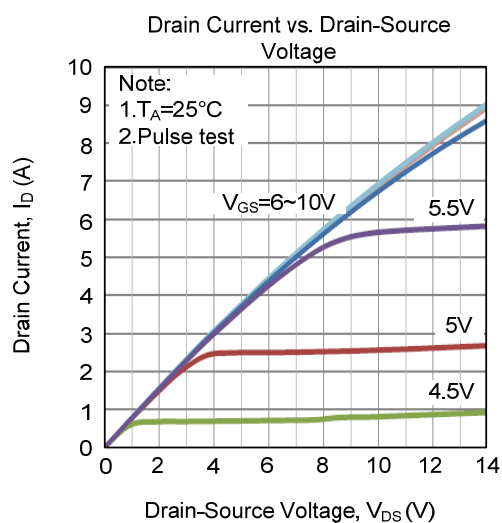


Unclamped Inductive Switching Test Circuit

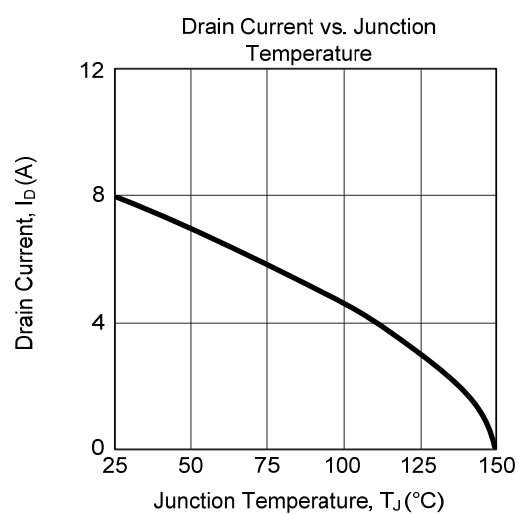
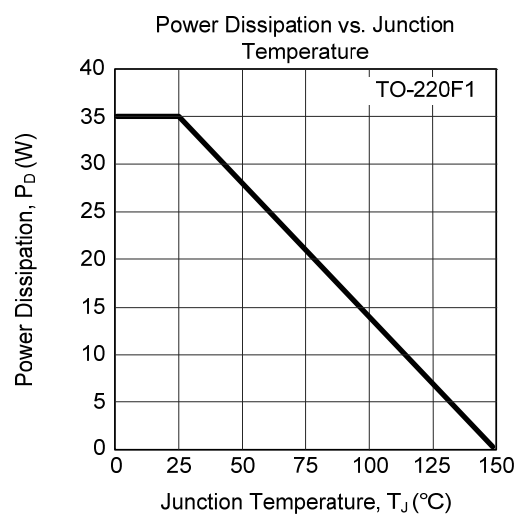
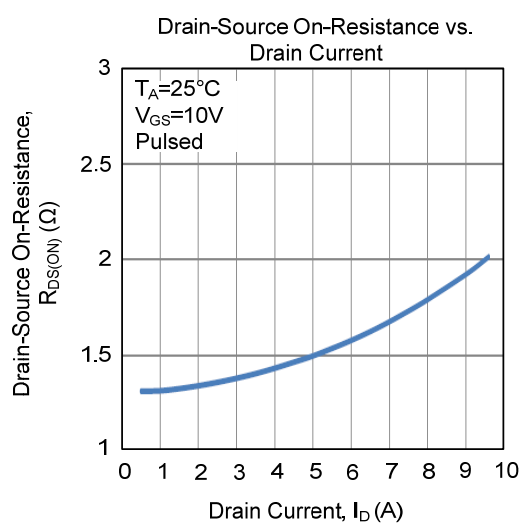
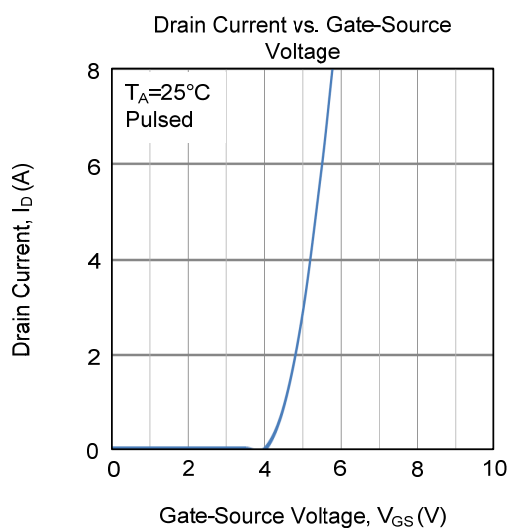
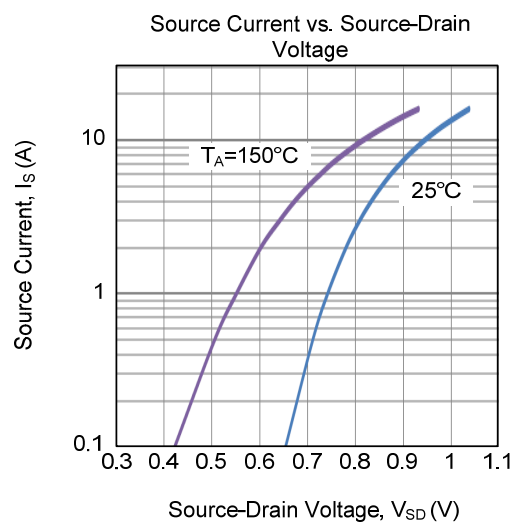
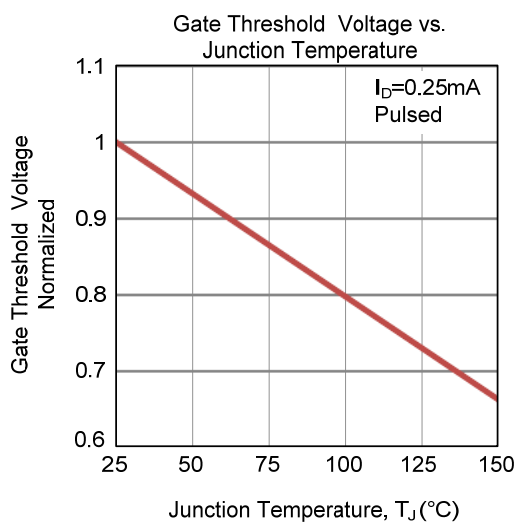


Unclamped Inductive Switching Waveforms

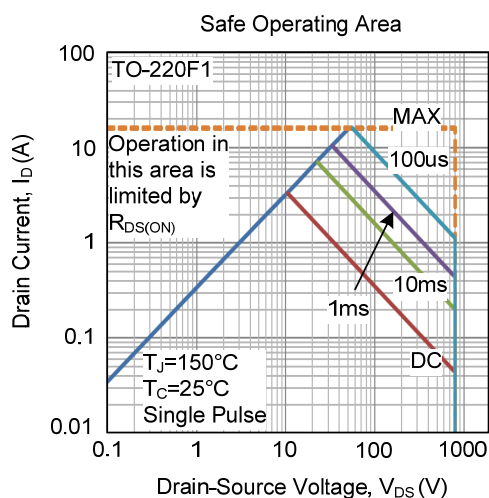
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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